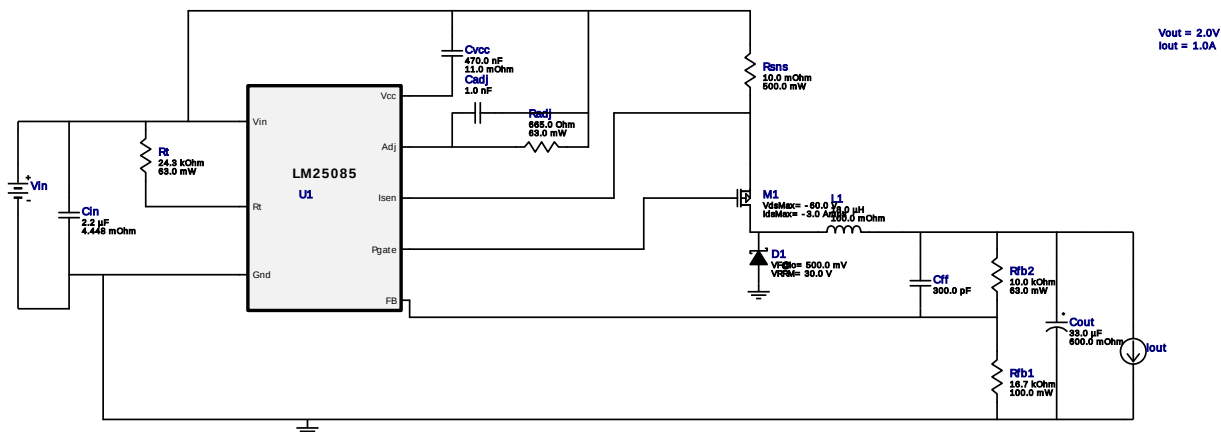


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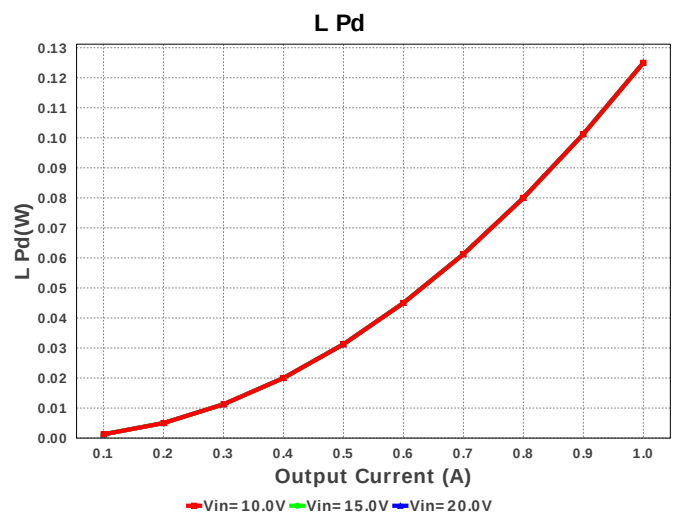
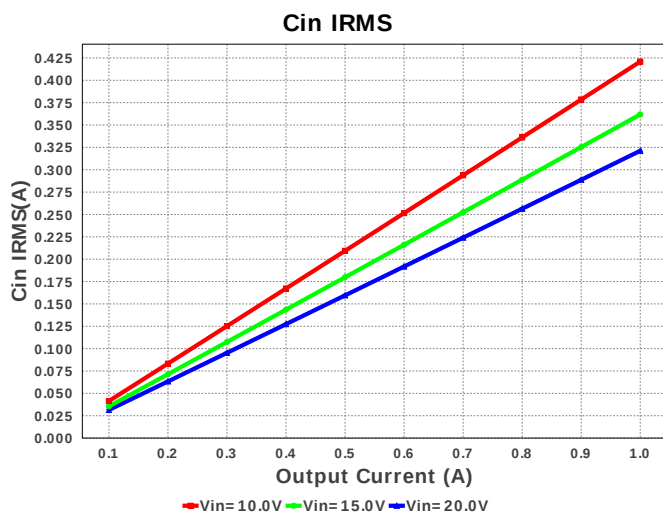
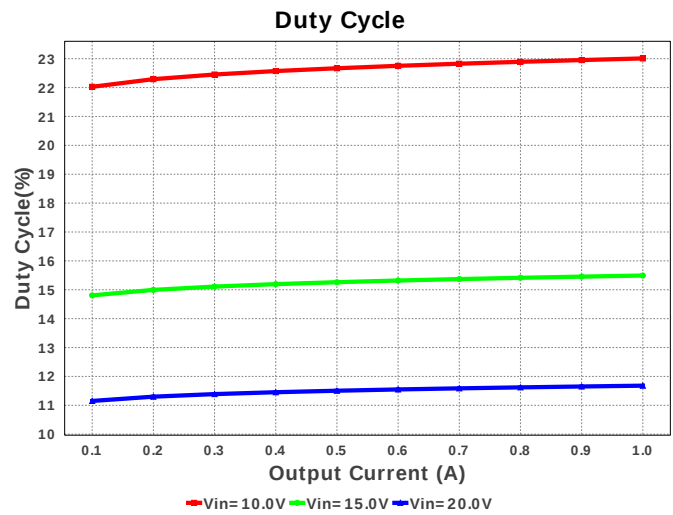
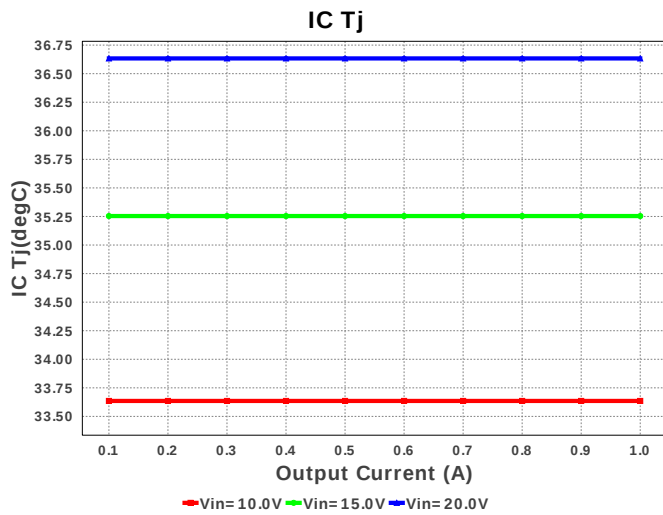
Design : 4728750/7 LM25085MY/NOPB
LM25085MY/NOPB 10.0V-20.0V to 2.00V @ 1.0A

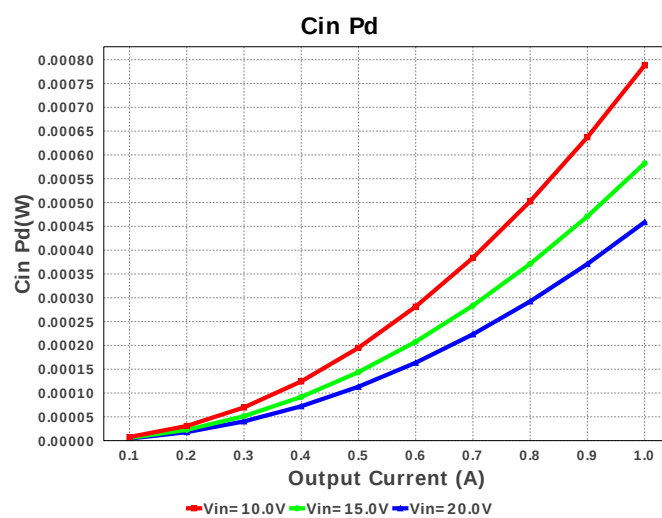
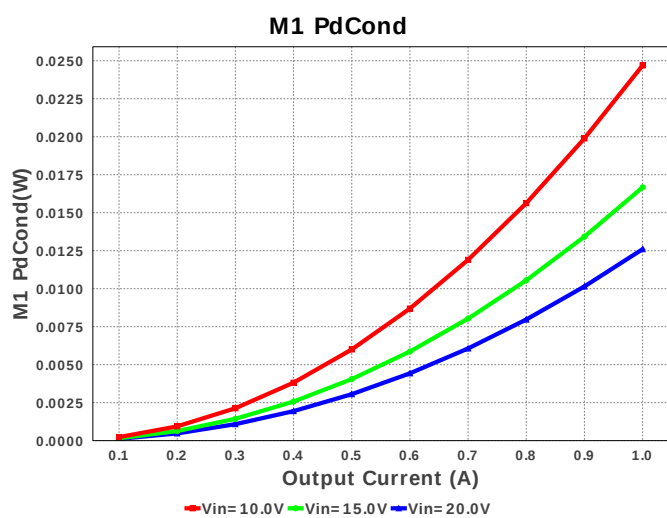
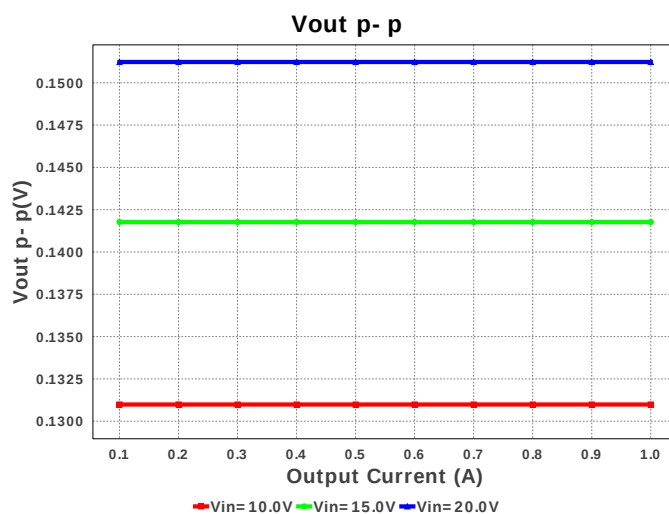
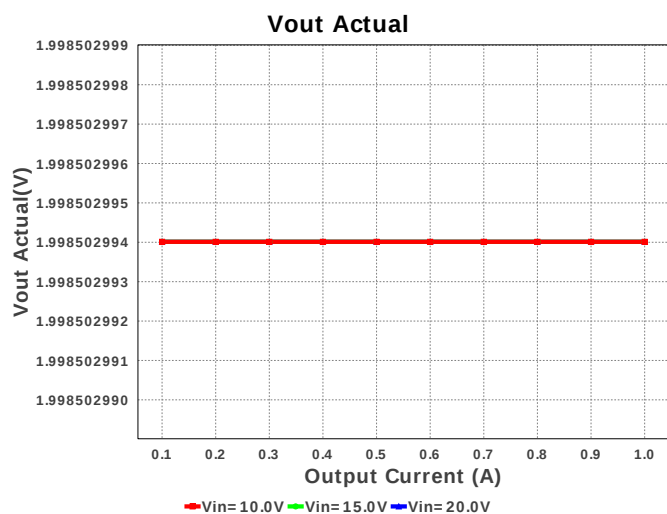
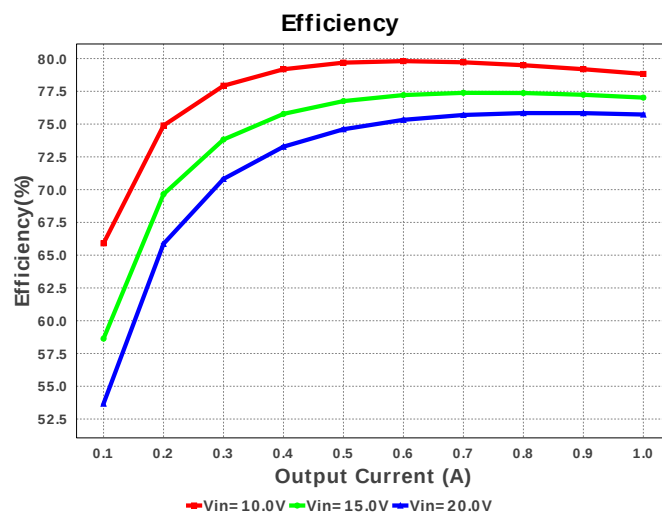
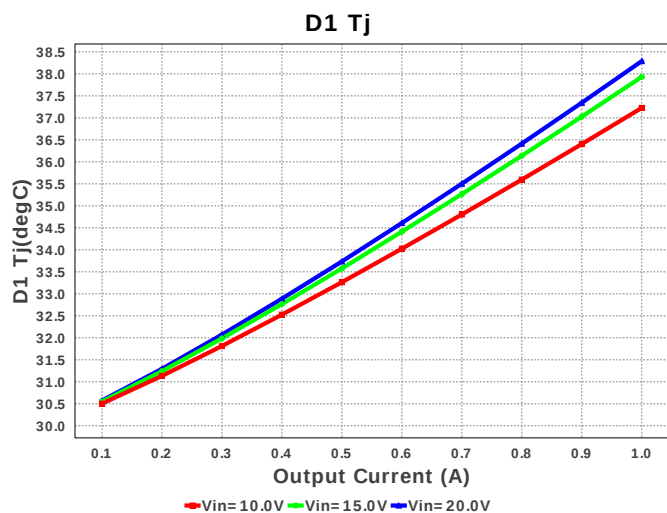


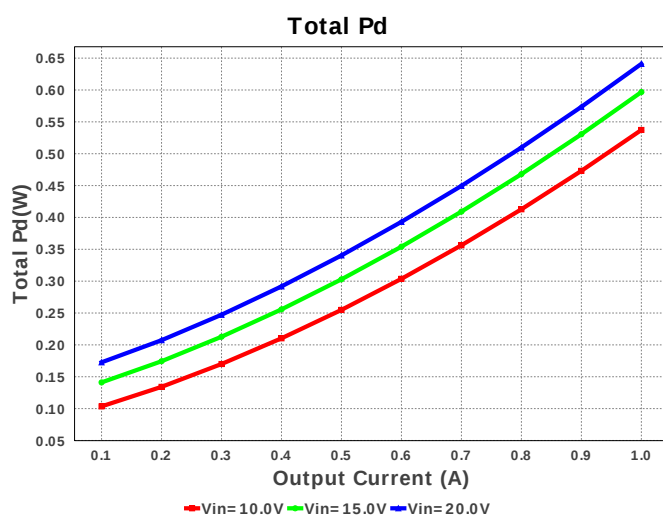
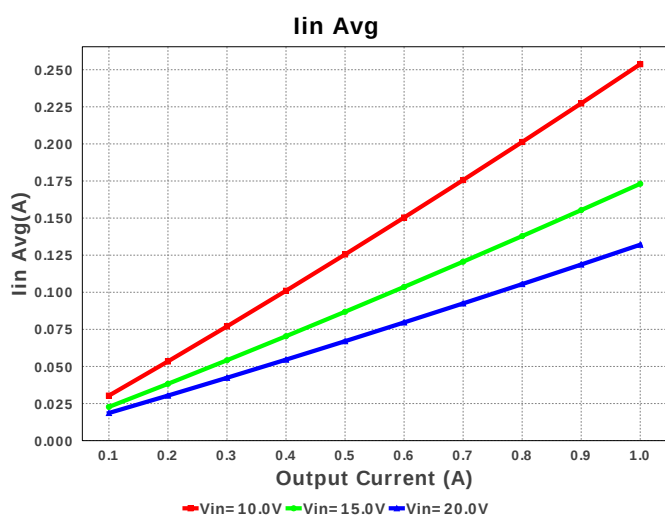
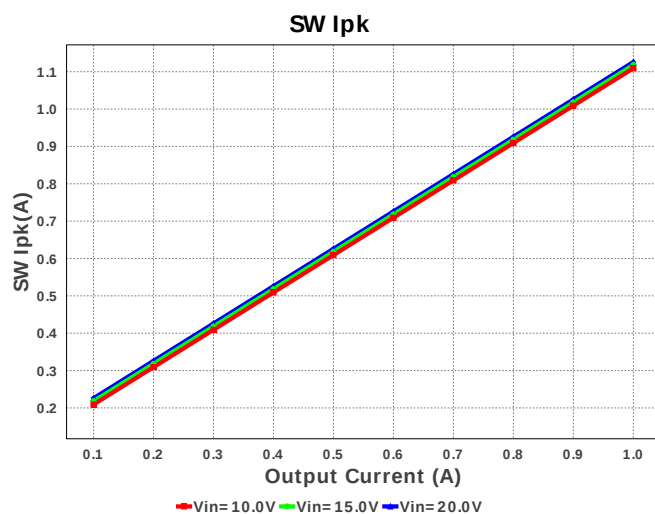
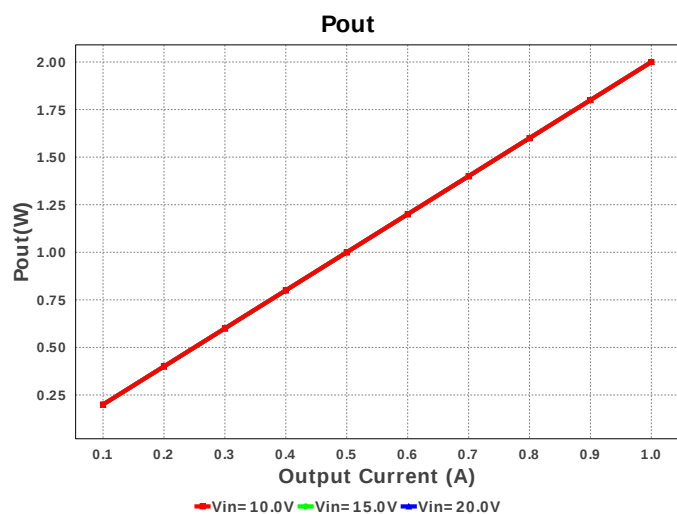
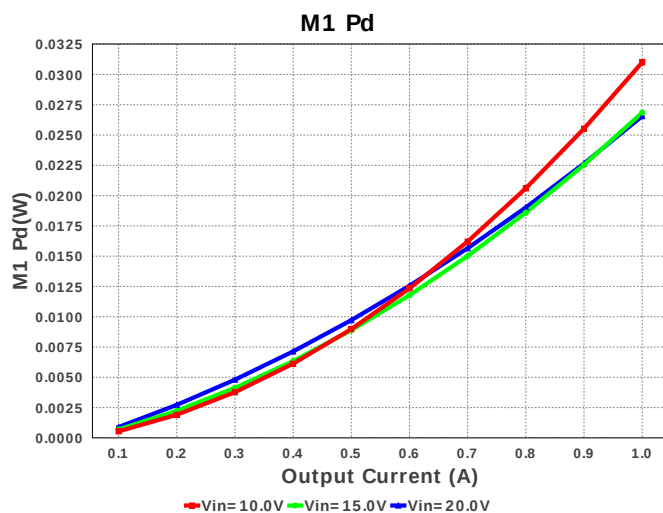
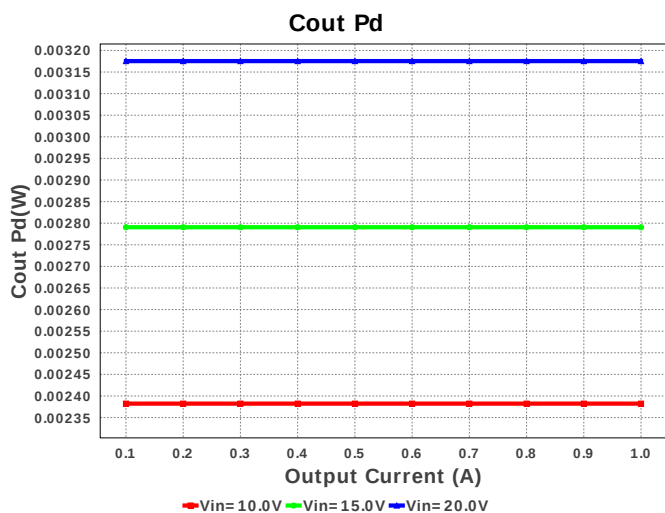
Electrical BOM

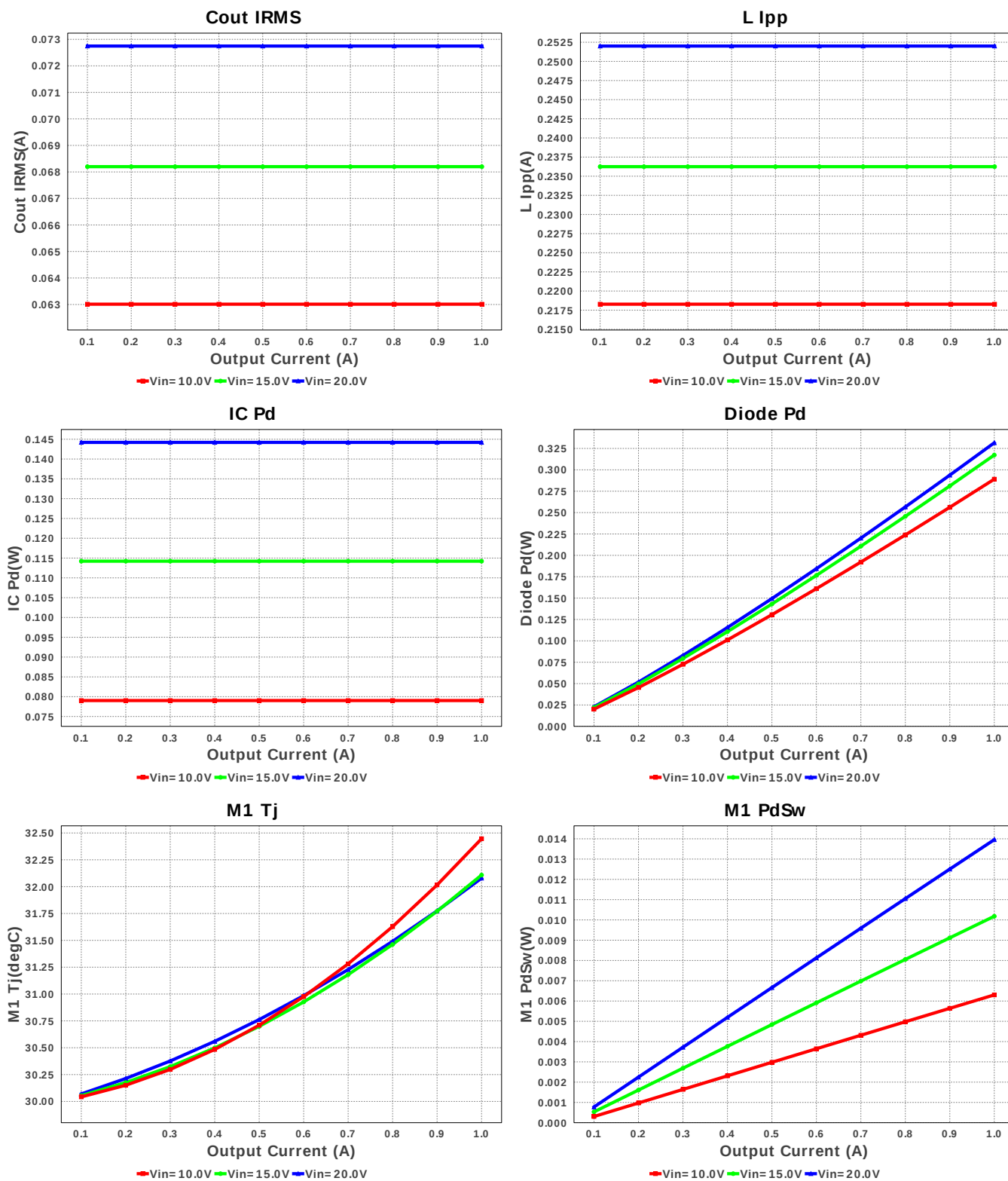
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Cadj	Samsung Electro-Mechanics	CL21C102JBCNFNC Series= C0G/NP0	Cap= 1.0 nF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	 0805 7 mm ²
2.	Cff	MuRata	GRM1555C1H301GA01D Series= C0G/NP0	Cap= 300.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	 0402 3 mm ²
3.	Cin	MuRata	GRM31CR71H225KA88L Series= X7R	Cap= 2.2 uF ESR= 4.448 mOhm VDC= 50.0 V IRMS= 2.2252 A	1	\$0.05	 1206_190 11 mm ²
4.	Cout	AVX	TPSA336K006R0600 Series= TPS	Cap= 33.0 uF ESR= 600.0 mOhm VDC= 6.3 V IRMS= 318.0 mA	1	\$0.13	 3216-18 11 mm ²
5.	Cvcc	AVX	0805YC474KAT2A Series= X7R	Cap= 470.0 nF ESR= 11.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.02	 0805 7 mm ²
6.	D1	Diodes Inc.	B230A-13-F	VF@Io= 500.0 mV VRRM= 30.0 V	1	\$0.09	 SMA 37 mm ²
7.	L1	NIC Components	NPI75C180MTRF	L= 18.0 uH DCR= 100.0 mOhm	1	\$0.11	 IND_NPI75C 94 mm ²
8.	M1	Fairchild Semiconductor	FDC5614P	VdsMax= -60.0 V IdsMax= -3.0 Amps	1	\$0.23	 SOT-23-6 15 mm ²
9.	Radj	Vishay-Dale	CRCW0402665RFKED Series= CRCW...e3	Res= 665.0 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
10.	Rfb1	Yageo America	RT0603BRD0716K7L Series= ?	Res= 16.7 kOhm Power= 100.0 mW Tolerance= 0.1%	1	\$0.04	 0603 5 mm ²

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
11.	Rfb2	Vishay-Dale	CRCW040210K0FKED Series= CRCW..e3	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
12.	Rsns	Stackpole Electronics Inc	CSR1206FK10L0 Series= ?	Res= 10.0 mOhm Power= 500.0 mW Tolerance= 1.0%	1	\$0.11	 1206 11 mm ²
13.	Rt	Vishay-Dale	CRCW040224K3FKED Series= CRCW..e3	Res= 24.3 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	 0402 3 mm ²
14.	U1	Texas Instruments	LM25085MY/NOPB	Switcher	1	\$0.70	 MUY08A 24 mm ²









Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	321.177 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	72.747 mA	Current	Output capacitor RMS ripple current
3.	Iin Avg	132.05 mA	Current	Average input current
4.	L Ipp	252.0 mA	Current	Peak-to-peak inductor ripple current
5.	SW Ipk	1.126 A	Current	Peak switch current
6.	BOM Count	14	General	Total Design BOM count
7.	FootPrint	233.0 mm ²	General	Total Foot Print Area of BOM components
8.	Frequency	331.122 kHz	General	Switching frequency
9.	IC Tolerance	25.0 mV	General	IC Feedback Tolerance
10.	Pout	2.0 W	General	Total output power
11.	Total BOM	\$1.53	General	Total BOM Cost

#	Name	Value	Category	Description
12.	D1 Tj	38.29 degC	Op_Point	D1 junction temperature
13.	Vout Actual	1.999 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
14.	Vout OP	2.0 V	Op_Point	Operational Output Voltage
15.	Duty Cycle	11.68 %	Op_point	Duty cycle
16.	Efficiency	75.728 %	Op_point	Steady state efficiency
17.	IC Tj	36.633 degC	Op_point	IC junction temperature
18.	ICThetaJA	46.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
19.	IOUT_OP	1.0 A	Op_point	Iout operating point
20.	M1 Tj	32.079 degC	Op_point	M1 MOSFET junction temperature
21.	VIN_OP	20.0 V	Op_point	Vin operating point
22.	Vout p-p	151.23 mV	Op_point	Peak-to-peak output ripple voltage
23.	Cin Pd	458.833 μ W	Power	Input capacitor power dissipation
24.	Cout Pd	3.175 mW	Power	Output capacitor power dissipation
25.	Diode Pd	331.617 mW	Power	Diode power dissipation
26.	IC Pd	144.204 mW	Power	IC power dissipation
27.	L Pd	125.0 mW	Power	Inductor power dissipation
28.	M1 Pd	26.564 mW	Power	M1 MOSFET total power dissipation
29.	M1 PdCond	12.606 mW	Power	M1 MOSFET conduction losses
30.	M1 PdSw	13.958 mW	Power	M1 MOSFET switching losses
31.	Total Pd	641.024 mW	Power	Total Power Dissipation
32.	Vout Tolerance	2.421 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	1.0	Maximum Output Current
2.	VinMax	20.0	Maximum input voltage
3.	VinMin	10.0	Minimum input voltage
4.	Vout	2.0	Output Voltage
5.	base_pn	LM25085	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. For a Constant On Time device to be stable, we need to provide a ripple at the feedback comparator. There are various methods to implement the ripple. Depending on the circuit complexity vs. the allowable ripple, we have three options to choose from. The simplest option, 'Low Complexity', would require only a high ESR cap at the output. This means that the BOM count will be small, but the output voltage ripple will be quite large. The 'optimal solution' would require a feed-forward cap in parallel with the upper feedback resistor to AC couple the ripple to the feedback node. This increases the BOM count slightly, but now we have more control over the output voltage ripple. If the output voltage requirement is very tight, then the best option is to go for the 'Low Output Ripple' solution. In this option we can go with very low ESR output caps and have very good control over the output voltage ripple

2. **LM25085 Product Folder** : <http://www.ti.com/product/LM25085> : contains the data sheet and other resources.

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